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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

application of:

Wolfgang Siebert et al.

Group Art Unit: 2823

Examiner: Trung Q. Dang

Serial No.: 10/731,034

Filed: December 9, 2003

For: EPITAXIALLY COATED SEMICONDUCTOR WAFER AND
PROCESS FOR PRODUCING IT

Attorney Docket No.: WSAG 0150 PUS

AMENDMENT UNDER 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
U.S. Patent and Trademark Office
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Sir:

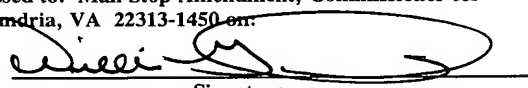
Responsive to the Office Action dated March 9, 2005, kindly amend the above-identified application as follows:

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

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